SLD 5.00/24/180G 3.2SN OR BX

Weidmüller Interface GmbH & Co. KG
Klingenbergstraße 26
D-32758 Detmold
Germany

www.weidmueller.com

Product image

Similar to illustration

2-tier male header with parallel pin arrangement. The solder pin length is optimised for wave flow soldering. The pin headers provide space for labelling and can be coded.

General ordering data

Version	PCB plug-in connector, male header, closed side, THT solder connection, 5.00 mm, Number of poles: 24, 180°, Solder pin length (l): 3.2 mm, tinned, orange, Box
Order No.	1614910000
Type	SLD 5.00/24/180G 3.2SN OR BX
GTIN (EAN)	4008190040222
Qty.	10 pc(s).
Product data	IEC: 400 V / 11 A UL: 300 V / 10 A
Packaging	Box

Creation date March 24, 2021 11:38:13 AM CET

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Technical data

Dimensions and weights

Depth	28.5 mm	Depth (inches)	1.122 inch
Height	25.2 mm	Height (inches)	0.992 inch
Height of lowest version	22 mm	Net weight	24.35 g
Width	61.96 mm	Width (inches)	2.439 inch

System specifications

Product family	OMNIMATE Signal - series BL/SL 5.00	Type of connection	Board connection
Mounting onto the PCB	THT solder connection	Pitch in mm (P)	5 mm
Pitch in inches (P)	0.197 inch	Outgoing elbow	180°
Number of poles	24	Number of solder pins per pole	1
Solder pin length (l)	3.2 mm	Solder pin length tolerance	+0.1 / -0.2 mm
Solder pin dimensions	d = 1.2 mm, Octagonal	Solder pin dimensions = d tolerance	0 / -0,03 mm
Solder eyelet hole diameter (D)	1.3 mm	Solder eyelet hole diameter tolerance (D)	+ 0,1 mm
L1 in mm	55 mm	L1 in inches	2.165 inch
Number of rows	2	Pin series quantity	2
Touch-safe protection acc. to DIN VDE 57 106	Safe from back-of-hand touch	Volume resistance	≤5 mΩ
Can be coded	Yes	Plugging force/pole, max.	3 N
Pulling force/pole, max.	3 N		

Material data

Insulating material	PBT	Colour	orange
Colour chart (similar)	RAL 2000	Insulating material group	IIIa
Comparative Tracking Index (CTI)	≥ 200	UL 94 flammability rating	V-0
Contact material	CuSn	Contact surface	tinned
Layer structure of solder connection	1...3 µm Ni / 2...4 µm Sn matt	Layer structure of plug contact	1...3 µm Ni / 2...4 µm Sn matt
Storage temperature, min.	-40 °C	Storage temperature, max.	70 °C
Operating temperature, min.	-50 °C	Operating temperature, max.	100 °C
Temperature range, installation, min.	-25 °C	Temperature range, installation, max.	100 °C

Rated data acc. to IEC

tested acc. to standard	IEC 60664-1, IEC 61984	Rated current, min. number of poles (Tu=20°C)	11 A
Rated current, max. number of poles (Tu=20°C)	8.5 A	Rated current, min. number of poles (Tu=40°C)	9.5 A
Rated current, max. number of poles (Tu=40°C)	7 A	Rated voltage for surge voltage class / pollution degree II/2	400 V
Rated voltage for surge voltage class / pollution degree III/2	320 V	Rated voltage for surge voltage class / pollution degree III/3	250 V
Rated impulse voltage for surge voltage class/ pollution degree II/2	4 kV	Rated impulse voltage for surge voltage class/ pollution degree III/2	4 kV
Rated impulse voltage for surge voltage class/ contamination degree III/3	4 kV	Short-time withstand current resistance	1 x 1s with 120 A

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Technical data

Rated data acc. to CSA

Institute (CSA)		Certificate No. (CSA)	200039-1121690
Rated voltage (Use group B / CSA)	300 V	Rated voltage (Use group D / CSA)	300 V
Rated current (Use group B / CSA)	10 A	Rated current (Use group D / CSA)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Rated data acc. to UL 1059

Institute (UR)		Certificate No. (UR)	E60693
Rated voltage (Use group B / UL 1059)	300 V	Rated voltage (Use group D / UL 1059)	300 V
Rated current (Use group B / UL 1059)	10 A	Rated current (Use group D / UL 1059)	10 A
Reference to approval values	Specifications are maximum values, details - see approval certificate.		

Packing

Packaging	Box	VPE length	1 mm
VPE width	1 mm	VPE height	1 mm

Classifications

ETIM 6.0	EC002637	ETIM 7.0	EC002637
ECLASS 9.0	27-44-04-02	ECLASS 9.1	27-44-04-02
ECLASS 10.0	27-44-04-02	ECLASS 11.0	27-46-02-01

Important note

IPC conformity	Conformity: The products are developed, manufactured and delivered according international recognized standards and norms and comply with the assured properties in the data sheet resp. fulfill decorative properties in accordance with IPC-A-610 "Class 2". Further claims on the products can be evaluated on request.
Notes	• Additional colours on request • Rated current related to rated cross-section & min. No. of poles. • Spacing between rows: see hole layout • P on drawing = pitch • Rated data refer only to the component itself. Clearance and creepage distances to other components are to be designed in accordance with the relevant application standards. • Long term storage of the product with average temperature of 50 °C and average humidity 70%, 36 months

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Technical data

Approvals

Approvals	
ROHS	Conform
UL File Number Search	E60693

Downloads

Approval/Certificate/Document of Conformity	Declaration of the Manufacturer
Engineering Data	STEP

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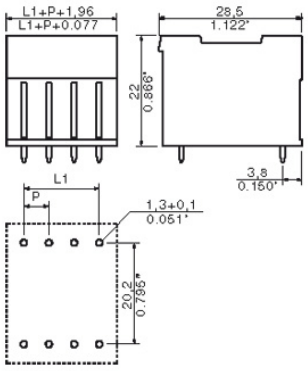
Drawings

Dimensional drawing



Wave Solder Profile

Recommended wave solderding profiles

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Fax: +49 5231 14-292083
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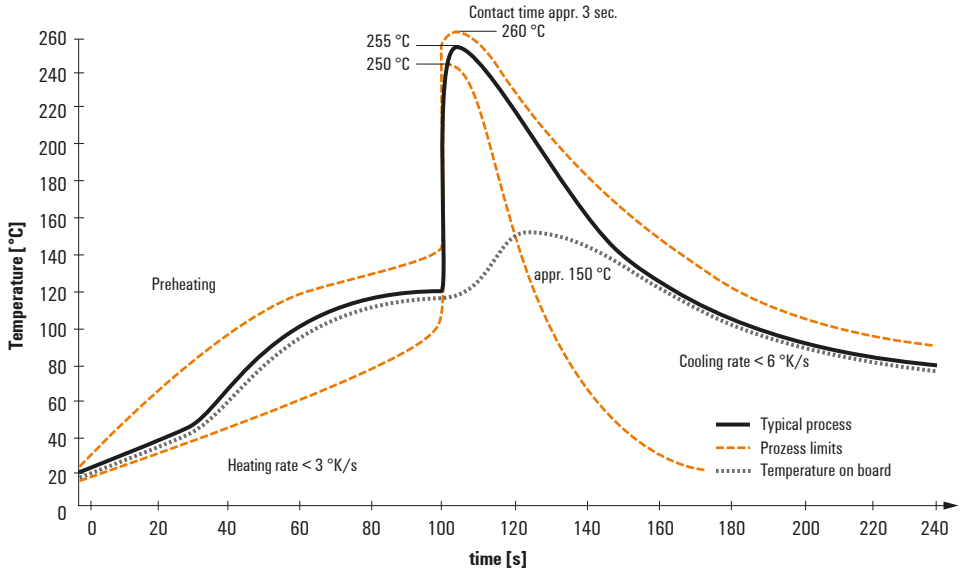
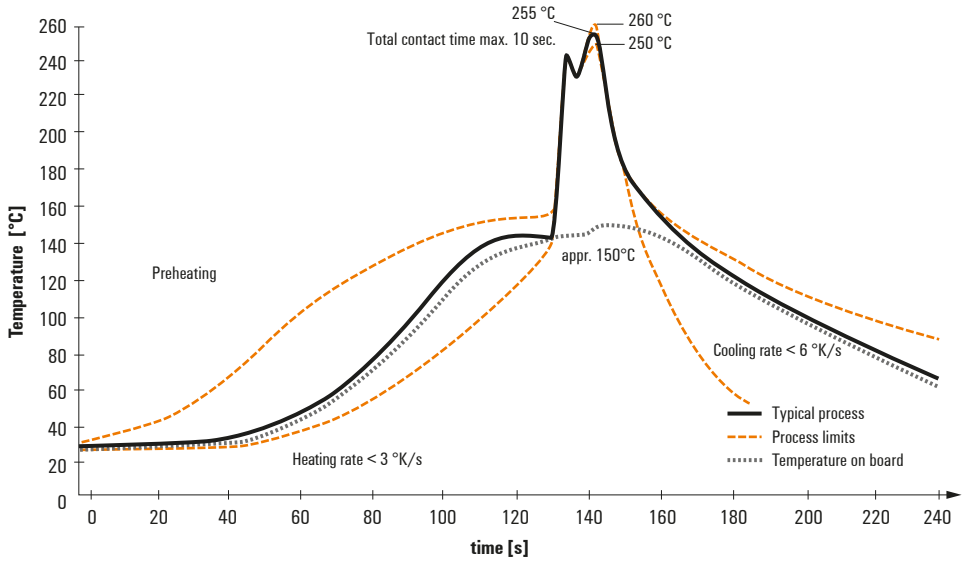
Single Wave:



Double Wave:



Wave soldering profiles

Wired connection elements should be processed in accordance with the DIN EN 61760-1 standard. We have included two recommendations for practical wave soldering profiles, with which Weidmüller PCB terminals and connectors are qualified.

When choosing a suitable profile for your application, the following factors also need to be considered:
- PCB thickness
- Proportion of Cu in the layers
- Single/double-sided assembly
- Product range
- Heating and cooling rates

The single and double wave profiles each indicate the recommended operating range, including the maximum soldering temperature of 260°C. In practice, the maximum soldering temperature is quite often well below the above maximum profile.

We reserve the right to make technical changes.